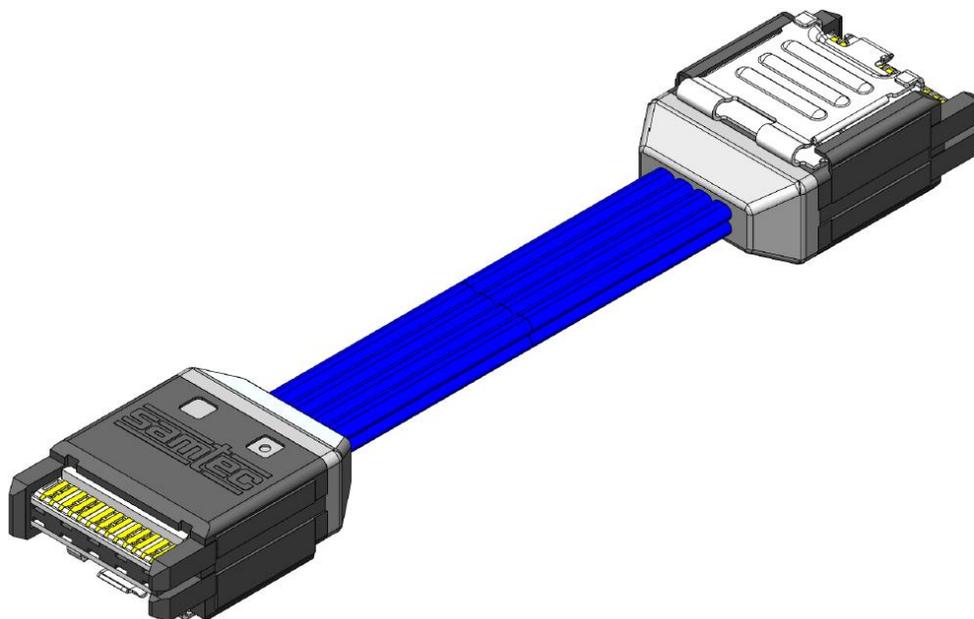
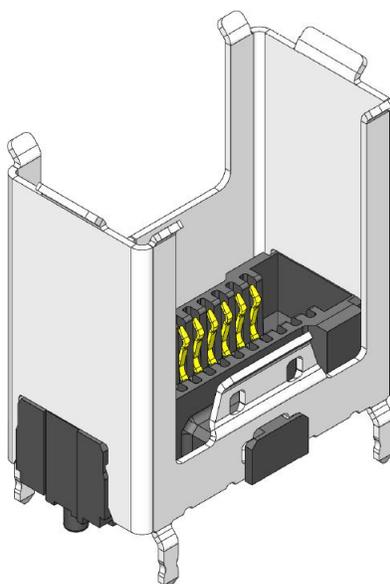


Series: **ARC6/ARF6** 0.635 mm (.025") AcceleRate® Slim Body Cable Assembly / Socket

**ARC6 Series – Terminal, Cable Assembly**



**ARF6 Series – Socket, Vertical Orientation**



**Other configurations available for:**

ARF6 Right Angle

See [www.samtec.com](http://www.samtec.com) for more information.

**Series:** ARC6/ARF6 0.635 mm (.025") AcceleRate® Slim Body Cable Assembly / Socket

## 1.0 SCOPE

**1.1** This specification covers performance, testing and quality requirements for Samtec's ARC6 / ARF6 Series 0.635 mm (.025") pitch AcceleRate® Slim Body Cable Assembly / Socket.

## 2.0 DETAILED INFORMATION

**2.1** Product prints, footprints, catalog pages, test reports and other specific, detailed information can be found at  
 ARC6: <https://www.samtec.com/products/arc6>  
 ARF6-DV: <https://www.samtec.com/products/arf6>  
 ARF6-RA <https://www.samtec.com/products/arf6-ra>

## 3.0 TESTING

**3.1 Current Rating:** 1.2A (1 Pin Powered per row)

**3.2 Voltage Rating:** 135 VAC

**3.3 Operating Temperature Range:** -40°C to +125°C

**3.4 Operating Humidity Range:** Up to 95% (Per EIA-364-31)

**3.5 Electrical:**

ITEM	TEST CONDITION	REQUIREMENT	STATUS
Withstanding Voltage	EIA-364-20 (No Flashover, Sparkover, or Breakdown)	405 VAC	Pass
Insulation Resistance	EIA-364-21 (1000 MΩ minimum)	45,000 MΩ	Pass
Contact Resistance (LLCR)	EIA-364-23	Δ 15 mΩ maximum (Samtec defined)/ No damage	Pass

**3.6 Mechanical:**

ITEM	TEST CONDITION	REQUIREMENT	STATUS
Durability	EIA-364-09C	25 cycles	Pass
Random Vibration	EIA-364-28 Condition V, Letter B 7.56 G 'RMS', 50 to 2000 Hz, 2 hours per axis, 3 axis total, PSD 0.04 Nanosecond Event Detection: EIA-364-87	Visual Inspection: No Damage LLCR: Δ 15 mΩ No Events	Pass
Mechanical Shock	EIA-364-27 100 G, 6 milliseconds, sawtooth wave, 11.3 fps, 3 shocks/direction, 3 axis (18 total shocks) Nanosecond Event Detection: EIA-364-87	Visual Inspection: No Damage LLCR: Δ 15 mΩ No Events	Pass
Normal Force	EIA-364-04	30 grams minimum for Gold interface	Pass

Series: **ARC6/ARF6** 0.635 mm (.025") AcceleRate® Slim Body Cable Assembly / Socket

### 3.7 Environmental:

ITEM	TEST CONDITION	REQUIREMENT	STATUS
Thermal Shock	EIA-364-32 Thermal Cycles: 100 (30 minute dwell) Hot Temp: +85°C Cold Temp: -55°C Hot/Cold Transition: Immediate	Visual Inspection: No Damage LLCR: $\Delta$ 15 m $\Omega$ DWV: 405 VAC IR: >45,000 M $\Omega$	Pass
Thermal Aging (Temp Life)	EIA-364-17 Test Condition 4 @ 105°C Condition B for 250 hours	Visual Inspection: No Damage LLCR: $\Delta$ 15 m $\Omega$	Pass
Cyclic Humidity	EIA-364-31 Test Temp: +25°C to +65°C Relative Humidity: 90 to 95% Test Duration: 240 hours	Visual Inspection: No Damage LLCR: $\Delta$ 15 m $\Omega$ DWV: 405 VAC IR: >45,000 M $\Omega$	Pass
Gas Tight	EIA-364-36 Gas Exposure: Nitric Acid Vapor Duration: 60 min. Drying Temp.: 50°C +/- 3°C Measurements: Within 1 hour of Exposure	LLCR: $\Delta$ 15 m $\Omega$	Pass

## 4.0 MATED SYSTEM

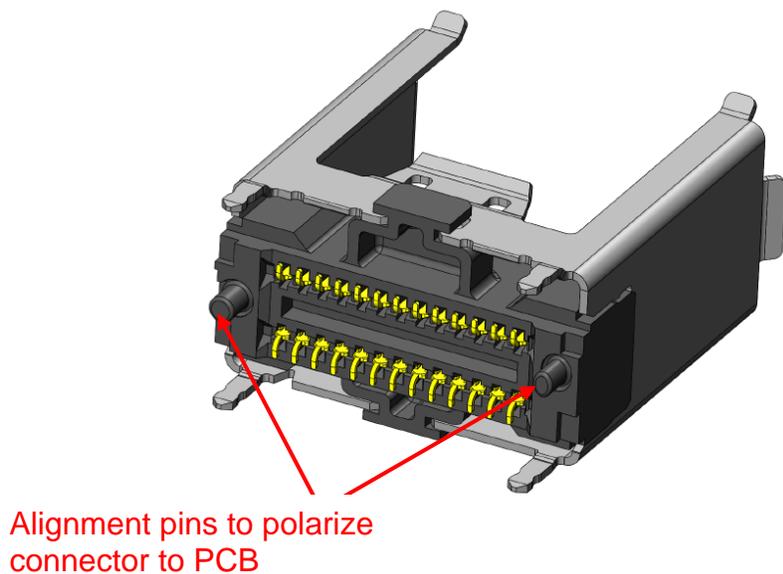
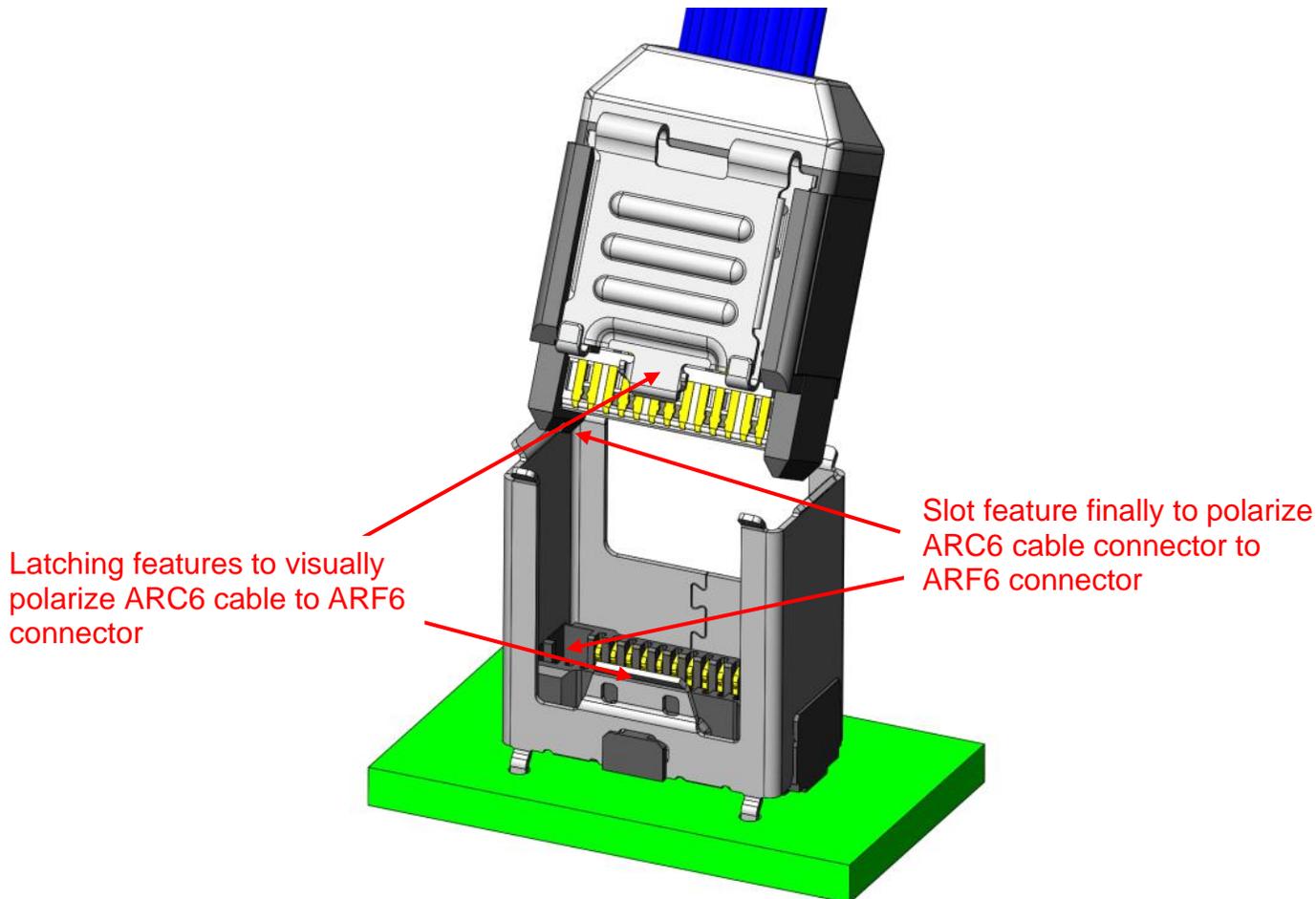
### 4.1 Mated views

Mated view information can be found at link below:

<http://suddendocs.samtec.com/prints/arx6%20mated%20document.pdf>

Series: ARC6/ARF6 0.635 mm (.025") AcceleRate® Slim Body Cable Assembly / Socket

### 5.0 POLARIZING FEATURES



Series: [ARC6/ARF6](#) 0.635 mm (.025") AcceleRate® Slim Body Cable Assembly / Socket

## 6.0 HIGH SPEED PERFORMANCE

### 6.1 Channel Simulation - Channel Performance Metric (CPM)



**Note:** CPM is a channel simulation-based approach to understanding connector performance. For further information on CPM please visit [Introducing Channel Performance](#).

CPM is simulated using a Samtec specific channel. Connector performance may improve based on specific applications. Please email the Samtec Signal Integrity Group [SIG@samtec.com](mailto:SIG@samtec.com) to determine performance in your system.

### 6.2 Empirical Testing – Based on -7dB insertion loss

ARC6 P/N	Frequency @ -7dB IL (mated to ARF6-DV)	Frequency @ -7dB IL (mated to ARF6-RA)
ARC6-XX-09.8-LU-XX-Z-1	29 GHz	Not Tested Yet
ARC6-XX-19.7-LU-XX-Z-1	19.5 GHz	Not Tested Yet
ARC6-XX-39.4-LU-XX-Z-1	10 GHz	Not Tested Yet

**Note:** The connector bandwidth is based on -7dB insertion loss point of the mated connector set. The -7dB point can be used to estimate usable system bandwidth in a typical two-level signaling environment.

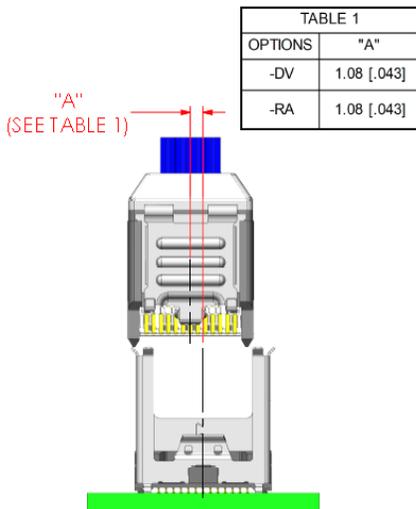
### 6.3 System Impedance: 100 Ohm for differential pair

Series: **ARC6/ARF6** 0.635 mm (.025") AcceleRate® Slim Body Cable Assembly / Socket

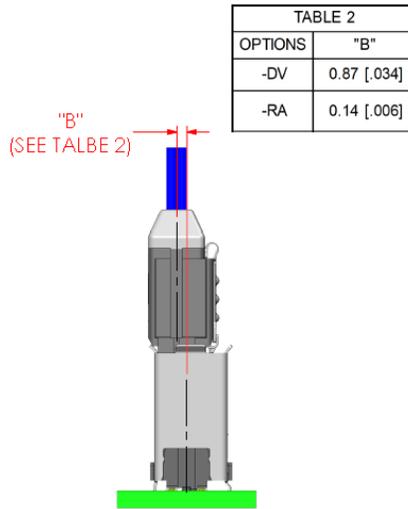
**7.0 PROCESSING RECOMMENDATIONS**

**7.1 Mating Alignment Requirements:**

**7.1.1 Allowable initial linear misalignment.**



INITIAL X AXIS LINEAR MISALIGNMENT

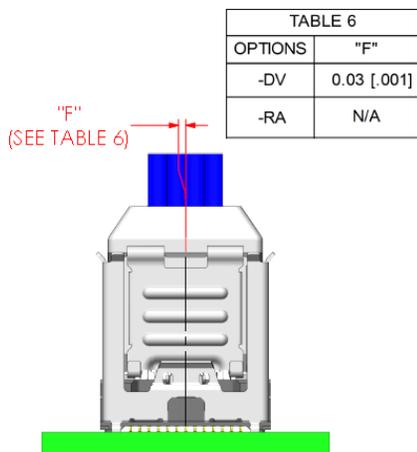


INITIAL Y AXIS LINEAR MISALIGNMENT

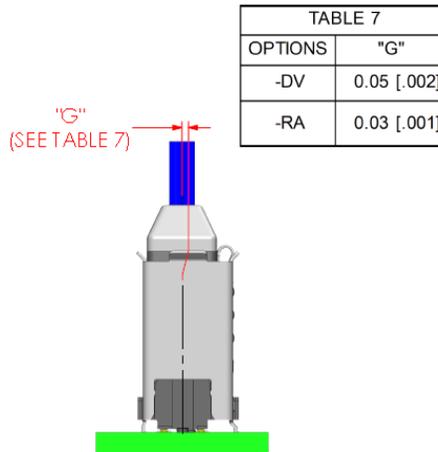
NON APPLICABLE

INITIAL Z AXIS LINEAR MISALIGNMENT

**7.1.2 Allowable final linear misalignment.**



FINAL X AXIS LINEAR MISALIGNMENT



FINAL Y AXIS LINEAR MISALIGNMENT

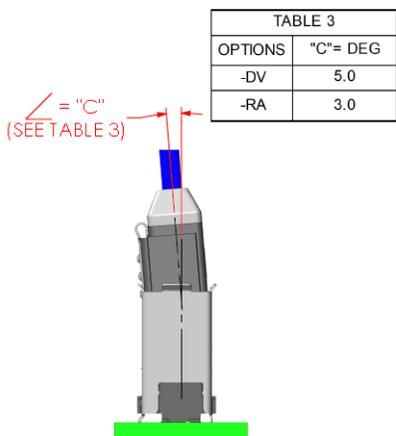
SEE 4.0 MATED VIEWS

FINAL Z AXIS LINEAR MISALIGNMENT

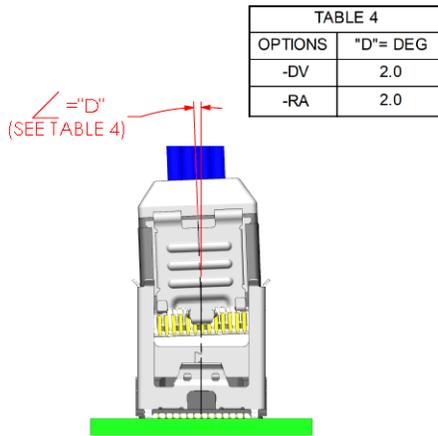
Series: ARC6/ARF6 0.635 mm (.025") AcceleRate® Slim Body Cable Assembly / Socket

## 7.2 Mating Angle Requirements

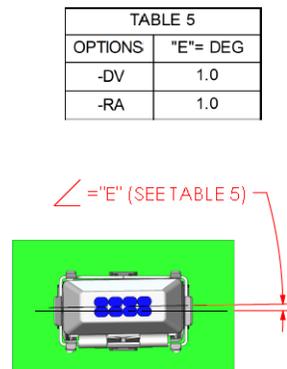
### 7.2.1 Allowable initial angular misalignment



INITIAL X AXIS ANGULAR MISALIGNMENT

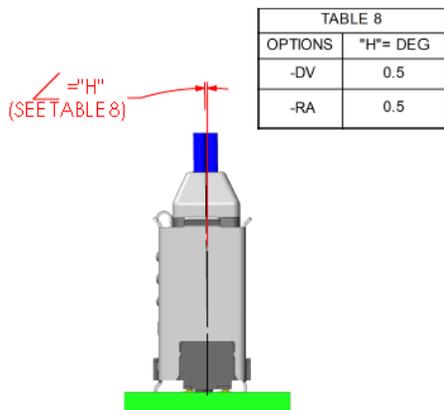


INITIAL Y AXIS ANGULAR MISALIGNMENT

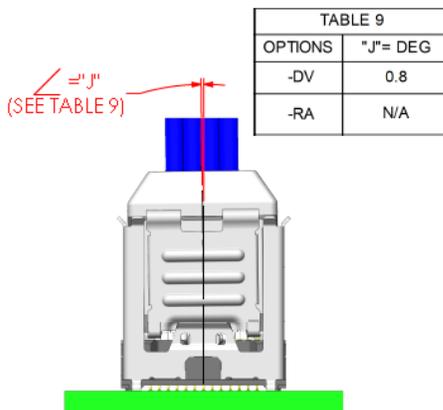


INITIAL Z AXIS ANGULAR MISALIGNMENT

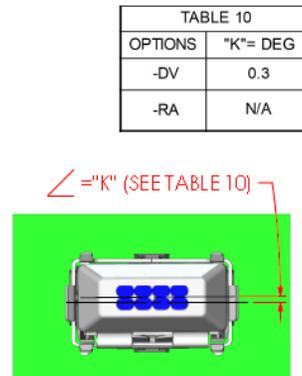
### 7.2.2 Allowable final angular misalignment



FINAL X AXIS ANGULAR MISALIGNMENT



FINAL Y AXIS ANGULAR MISALIGNMENT



FINAL Z AXIS ANGULAR MISALIGNMENT

Series: **ARC6/ARF6** 0.635 mm (.025") AcceleRate® Slim Body Cable Assembly / Socket

**7.3 Thermal Profile:** Due to variances in equipment, solder pastes and applications (board design, component density, etc.), Samtec does not specify a recommended reflow profile for our connectors. The processing parameters provided by the solder paste manufacturer should be employed and can usually be found on their website.

All of Samtec’s surface mount components are lead free reflow compatible and compliant with the profile parameters detailed in IPC/JEDEC J-STD-020 which requires that components be capable of withstanding a peak temperature of 260°C as well as 30 seconds above 255°C.

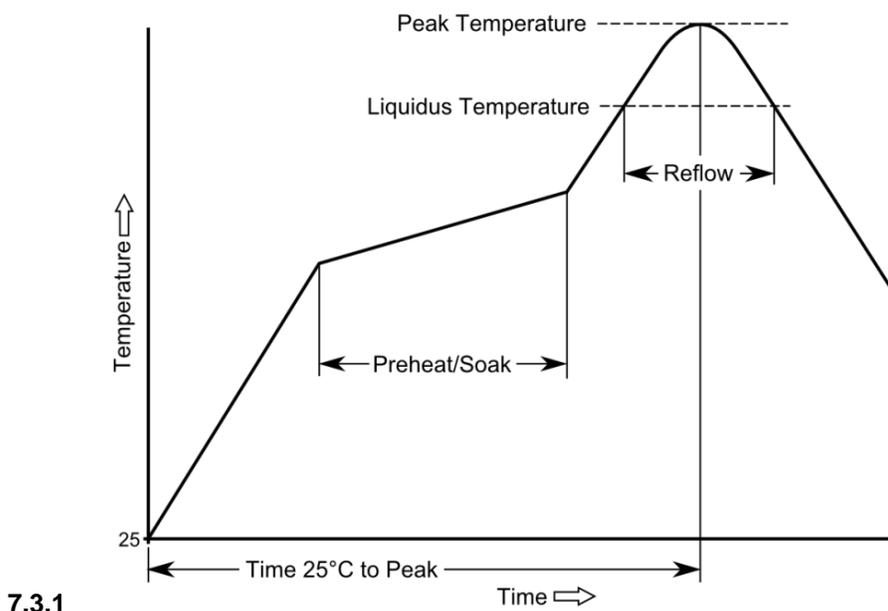
**Samtec Recommended Temperature Profile Ranges (SMT)**

**Sn-Pb Eutectic Assembly**

Preheat/Soak (100°C-150°C)	Max Ramp Up Rate	Reflow Time (above 183°C)	Peak Temp	Time within 5°C of 235°C	Max Ramp Down Rate	Time 25°C to Peak Temp
60-120 sec.	3°C/s max.	40-150 sec.	235°C	20 sec. max.	6°C/s max.	6 min. max.

**Pb-Free Assembly**

Preheat/Soak (150°C-200°C)	Max Ramp Up Rate	Reflow Time (above 217°C)	Peak Temp	Time within 5°C of 260°C	Max Ramp Down Rate	Time 25°C to Peak Temp
60-120 sec.	3°C/s max.	40-150 sec.	260°C	30 sec. max.	6°C/s max.	8 min. max.



These guidelines should not be considered design requirements for all applications. Samtec recommends testing interconnects on your boards in your process to guarantee optimum results.

**7.4 Maximum Reflow Passes:** The parts can withstand three reflow passes at a maximum component temperature of 260°C.

**Series:** [ARC6/ARF6](#) 0.635 mm (.025") AcceleRate® Slim Body Cable Assembly / Socket

**7.5 Stencil Thickness:** The stencil thickness is .006" (0.15 mm)

**7.6 Min Cable Bend Radius:** TX-34100CU-01-S = .125" (3.17 mm) for less than a 1 Ohm drop.

**7.7 Placement:** Machine placement is strongly recommended.

**7.8 Reflow Environment:** Samtec recommends the use of a low-level oxygen environment (typically achieved through Nitrogen gas infusion) in the reflow process to improve solderability.

**7.9 Cleaning:** Samtec, Inc. has verified that our connectors may be cleaned in accordance with the solvents and conditions designated in the EIA-364-11 standard.

## 8.0 ADDITIONAL RESOURCES

**8.1** For additional mechanical testing or product information, contact our Customer Engineering Support Group at [CES@samtec.com](mailto:CES@samtec.com)

**8.2** For additional information on high speed performance testing, contact our Signal Integrity Group at [SIG@samtec.com](mailto:SIG@samtec.com)

**8.3** For additional processing information, contact our Interconnect Processing Group at [IPG@samtec.com](mailto:IPG@samtec.com).

**8.4** For RoHS, REACH or other environmental compliance information, contact our Product Environmental Compliance Group at [PEC@samtec.com](mailto:PEC@samtec.com)

### USE OF PRODUCT SPECIFICATION SHEET

This Product Specification Sheet ("PSS") is a brief summary of information related to the Product identified. As a summary, it should only be used for the limited purpose of considering the purchase/use of Product. For specific, detailed information, including but not limited to testing and Product footprint, refer to Section 2.0 of this document and the links there provided to test reports and prints. This PSS is the property of Samtec, Inc. ("Samtec") and contains proprietary information of Samtec, our various licensors, or both. Samtec does not grant express or implied rights or license under any patent, copyright, trademark or other proprietary rights and the use of the PSS for building, reverse engineering or replication is strictly prohibited. By using the PSS, the user agrees to not infringe, directly or indirectly, upon any intellectual property rights of Samtec and acknowledges that Samtec, our various licensors, or both own all intellectual property therein. The PSS is presented "AS IS". While Samtec makes every effort to present excellent information, the PSS is only provided as a guideline and does not, therefore, warrant it is without error or defect or that the PSS contains all necessary and/or relevant information about the Product. The user agrees that all access and use of the PSS is at its own risk. **NO WARRANTIES EXPRESSED OR IMPLIED, INCLUDING ANY WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR OF ANY KIND WHATSOEVER ARE PROVIDED.**